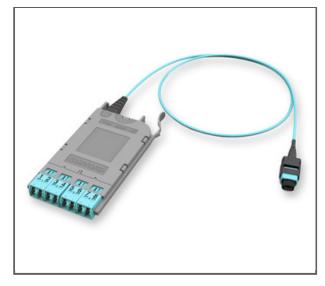
EDGE8® Port Breakout Module 8F, LC Duplex to 3 m LSZH™/FRNC Interconnect MTP® (non-pinned), 50 μm multimode (OM4), Type B



Part Number: ECM8-05E6-QEZB-003M

EDGE8 MTP® port breakout modules enable conversion from a single 4-channel parallel optic port (such as 40GSR4 (QSFP), to a patch panel representation with four LC duplex ports for use in a main distribution area.



Features and Benefits

VFL-compatible shuttered LC adapters

Creates one-hand operation and decreases time needed to test and troubleshoot a link

Rear-loading capability

Decreases the time to prepare and install modules into fiber housings

High density

Module enables 576 fibers in a 4U housing and 144 fibers in a 1U

Low insertion loss performance

Improved performance specs allow for more mated pairs and/or longer link distances

Corning® CleanAdvantage™ technology and optimized dust cap

Eliminates the need for scoping and cleaning prior to initial field connection

EDGE8® Port Breakout Module 8F, LC Duplex to 3 m LSZH™/FRNC Interconnect MTP® (non-pinned), 50 μm multimode (OM4), Type B



Specifications

Ordering Information	
Package Contents	Port Breakout Modules packaged in individual plastic bags
Units per Delivery	1/1

Design	
Housing Type	Panels and Modules

General Specifications	
Product Type	Panels and Modules
Cable Type	Interconnect
Application	Data Center LAN/SAN

Standards	
RoHS	Free of hazardous substances according to RoHS 2011/65/EU



Corning Optical Communications GmbH & Co. KG • Lelpziger Strasse 121 • 10117 Berlin, Germany +00 800 2675 4641 • FAX: +49 30 5303 2335 • www.corning.com/opcomm/emea